

| | | |
|---|-----------------------------|---------------------|
| LIST OF REFERENCES CITED BY APPLICANT (Use several sheets if necessary) | Application Number | 10/596,304 |
| | Filing Date | June 8, 2006 |
| | First Named Inventor | Spiros GRATSIAS |
| | Art Unit | 3724 |
| | Examiner Name | Hwei Siu Chou PAYER |
| | Attorney Docket No. | 11348-021-999 |

U.S. PATENT DOCUMENTS

| *Examiner Initials | Cite No. | Document Number -- Kind Code | Publication Date mm/dd/yyyy | Name of Patentee or Applicant of Cited Document | Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear |
|--------------------|----------|------------------------------|-----------------------------|---|---|
| | A01 | | | | |
| | A02 | | | | |
| | A03 | | | | |
| | A04 | | | | |
| | A05 | | | | |
| | A06 | | | | |
| | A07 | | | | |

FOREIGN PATENT DOCUMENTS

| *Examiner Initials | Cite No. | Foreign Patent Document Country Code, Number, Kind Code (if known) | Publication Date mm/dd/yyyy | Name of Patentee or Applicant of Cited Document | Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear | T |
|--------------------|----------|--|-----------------------------|---|---|---|
| | B01 | JP 2001-276450 | 10/09/2001 | Zaza International KK | | |
| | B02 | | | | | |
| | B03 | | | | | |
| | B04 | | | | | |
| | B05 | | | | | |
| | B06 | | | | | |
| | B07 | | | | | |

NON PATENT LITERATURE DOCUMENTS

| *Examiner Initials | Cite No. | Include name of the author (in CAPITAL LETTERS), (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published. | T |
|--------------------|----------|--|---|
| | C01 | | |
| | C02 | | |
| | | | |

NYI-4257317v1

**EXAMINER
SIGNATURE****DATE CONSIDERED**

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.